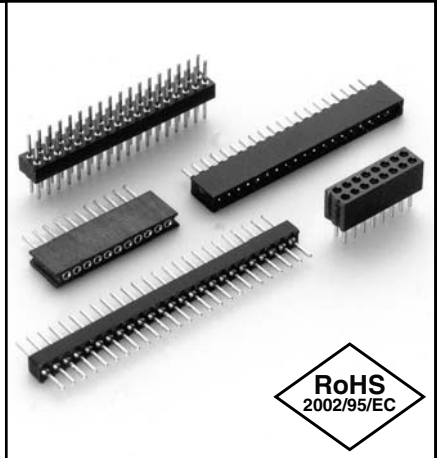


- Series 850 single and double row interconnects have 1,27 pin spacing & permit board stacking as low as 6,3.
- Pin headers have 0,41 dia. pins (MM #4006-0). See page 175 for details.
- MM #0467 and MM #4890 receptacles use Hi-Rel, 3-finger BeCu #11 contacts rated at 3 amps. (#11 contact accepts pin diameters from 0,38 - 0,51). See pages 129 and 131 for details.
- Insulators are high temp. thermoplastic, suitable for all soldering operations.



Ordering Information

Fig. 1	Single Row	2,21 Profile Pin Header
	Specify # of pins	850-XX-0__-10-001000 └──────────┬──────────> 01-50
Fig. 2	Double Row	1,91 Profile Pin Header
	Specify # of pins	852-XX-__-10-001000 └──────────┬──────────> 002-100

For Electrical, Mechanical & Environmental Data, See pg. 4

XX=Plating Code See Below

For RoHS compliance select ◇ plating code.

SPECIFY PLATING CODE XX=	10 ◇	90	40 ◇	
Pin Plating	0,25µm Au	5,08µm Sn/Pb	5,08µm Sn	

Fig. 3	Single Row	4,09 Profile Socket
	Specify # of pins	851-XX-0__-10-001000 └──────────┬──────────> 01-50
Fig. 4	Double Row	4,09 Profile Socket
	Specify # of pins	853-XX-__-10-001000 └──────────┬──────────> 002-100
Fig. 5	Single Row	4,7 Profile Socket
	Specify # of pins	851-XX-0__-10-002000 └──────────┬──────────> 01-77

For Electrical, Mechanical & Environmental Data, See pg. 4

XX=Plating Code See Below

For RoHS compliance select ◇ plating code.

SPECIFY PLATING CODE XX=		93	99	43 ◇	
Sleeve (Pin)		5,08µm Sn/Pb	5,08µm Sn/Pb	5,08µm Sn	
Contact (Clip)		0,76µm Au	5,08µm Sn/Pb	0,76µm Au	